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# Atomistic Full-Band Simulations of Si Nanowire Transistors: Effects of Electron-Phonon Scattering

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## Abstract

An atomistic full-band quantum transport simulator has been developed to study three-dimensional Si nanowire field-effect transistors (FETs) in the presence of electron-phonon scattering. The Non-equilibrium Green's Function (NEGF) formalism is solved in a nearest-neighbor  $sp^3d^5s^*$  tight-binding basis. The scattering self-energies are derived in the self-consistent Born approximation to inelastically couple the full electron and phonon energy spectra. The band dispersion and the eigenmodes of the confined phonons are calculated using a dynamical matrix that includes the bond and the angle deformations of the nanowires. The optimization of the numerical algorithms and the parallelization of the NEGF scheme enable the investigation of nanowire structures with diameters up to 3 nm and lengths over 40 nm. It is found that the reduction of the device drain current, caused by electron-phonon scattering, is more important in the ON-state than in the OFF-state of the transistor. Ballistic transport simulations considerably overestimate the device ON-currents by artificially increasing the charge injection mechanism at the source contact.

## I. INTRODUCTION

Semiconductor nanowires (NW) have emerged as potential active components of future integrated circuits beyond the conventional metal-oxide-semiconductor field-effect transistor (MOSFET) technology<sup>1</sup>. Nanowires made of different materials, crystal orientations, cross section shapes, and dimensions have been successfully synthesized opening novel perspectives in both electronics and optoelectronics<sup>2–10</sup>. As field-effect transistors (FETs), nanowires provide an excellent electrostatic control of the channel due to their one-dimensional transport properties and can therefore operate at lower supply voltages than the traditional MOSFETs.

The fabrication of nanowire FETs is still a technology under development, that requires further innovations before challenging state-of-the-art MOSFETs. Physics-based device simulations can support the experimental work to accelerate the development of NW FETs, reduce their cost, identify their strength and weakness, and demonstrate their scalability down to the sub 20 nm range. Classical and semi-classical approaches like drift-diffusion<sup>11</sup> and the Boltzmann transport equation<sup>12</sup> are very popular among the semiconductor industry for their ability to deliver simulation results in a short time. However, at the nanometer scale, these methods fail and must be replaced by computationally more intensive, but physically more accurate quantum mechanical models that include an atomistic device representation.

Ballistic simulations of NW FETs based on an effective mass treatment of the Schrödinger equation<sup>13–15</sup> represent a substantial advancement as compared to drift-diffusion and the Boltzmann equation, but they do not correctly capture the quantization of the energy levels in structures with a cross section smaller than  $5\text{ nm} \times 5\text{ nm}$ <sup>16</sup>. To overcome the limitations of the effective mass approximation, full-band three-dimensional (3-D) transport simulations of NW FETs based on tight-binding-like orbital basis have been recently reported<sup>17–20</sup>. In these atomistic studies, the diameters of the nanowires do not exceed 1.5 nm, with the notable exception of Ref.<sup>20</sup>, where a more efficient numerical approach<sup>21,22</sup> has been used, that enables the simulation of devices with diameters up to 10 nm.

Apart from the electron and hole bandstructure and 3-D electrostatic charging effects, the interactions of the free carriers with their environment (impurities, open surfaces, or lattice vibrations) strongly affect the performances of NW FETs. For example, electron-phonon scattering is expected to drastically deteriorate the ON-current of devices with diameters

below 5 nm<sup>10</sup>. Modeling such many-body, inelastic interaction phenomena at a quantum mechanical level is computationally very challenging. The Non-equilibrium Green's Function Formalism (NEGF)<sup>23–26</sup> has established itself as a theoretically well established approach to account for electron-phonon scattering in device simulations. Due to the complexity of the physical models, the 3-D simulators that include dissipative scattering are based on the effective mass approximation (no atomistic representation) and decouple the current transport direction from the transverse directions of confinement (mode-space approach reducing transport to a 1-D problem)<sup>27–31</sup>.

There have been some attempts to include both a multi-band tight-binding model and electron-phonon scattering into a single device simulator using the NEGF formalism, but they have been restricted to one-dimensional (1-D) structures only, like resonant tunneling diodes<sup>32,33</sup> and quantum well solar cells<sup>34</sup> or to molecules composed of very few atoms, typically less than 20<sup>35–37</sup>. Finally, alternative methods to NEGF have been considered to treat electron-phonon scattering in ultrascaled NW FETs like the Pauli Master Equation<sup>38</sup> and a modified Monte-Carlo approach<sup>39</sup>.

In this paper, a 3-D, atomistic simulation approach that combines a full-band model and electron-phonon scattering in the self-consistent Born approximation is presented. The nearest-neighbor  $sp^3d^5s^*$  tight-binding method and the NEGF formalism are used together to simulate quantum transport in Si nanowire FETs. The electron-phonon interaction is calculated directly from the tight-binding Hamiltonian and from the band dispersion and the eigenmodes of the phonons confined in the nanowire structures. Despite the heavy computational burden of this atomistic approach, circular gate-all-around NW FETs longer than 40 nm, with diameters up to 3 nm, and composed of more than 14,000 atoms are considered. The availability of large supercomputers and the efficient parallelization of the different tasks are essential to reach these dimensions that no other full-band simulator, even ballistic, has been able to treat so far<sup>40</sup>. The degradation of the ON-current due to electron-phonon scattering in Si NW FETs with diameters of 2, 2.5 and 3 nm is investigated as an application.

The paper is organized as follows: in Section II, the simulation approach is introduced, from the rigorous calculation of the electron-phonon self-energies and of the Green's Functions to the necessary simplifications and approximations to keep the computational burden manageable. Details about the numerical implementation are given in Appendix A. Ap-

plications of the formalism to different Si NW FET structures and the analysis of their ON-currents are shown in Section III. The paper is concluded in Section IV and an outlook on future device simulations is given.

## II. THEORY

### A. General Formalism Description

Electron-phonon scattering is treated in the framework of the Non-equilibrium Green's Function (NEGF) formalism under steady-state conditions<sup>23–26,41,42</sup>. The lesser ( $G^<$ ), the greater ( $G^>$ ), and the retarded ( $G^R$ ) Green's Functions are expressed in a nearest-neighbor tight-binding basis according to<sup>21,32</sup>

$$\sum_l \{ [\mathbf{E} - \mathbf{E}_n - \mathbf{V}(\mathbf{R}_n)] \delta_{l,n} - \mathbf{H}_{nl} - \Sigma_{nl}^{RB}(E) - \Sigma_{nl}^{RS}(E) \} \cdot \mathbf{G}_{lm}^R(E) = \delta_{nm}, \quad (1)$$

$$\mathbf{G}_{nm}^{\geq}(E) = \sum_{l_1 l_2} \mathbf{G}_{nl_1}^R(E) \cdot \left[ \Sigma_{l_1 l_2}^{\geq B}(E) + \Sigma_{l_1 l_2}^{\geq S}(E) \right] \cdot \mathbf{G}_{l_2 m}^A(E), \quad (2)$$

$$\Sigma_{nm}^R(E) = \frac{1}{2}(\Sigma_{nm}^>(E) - \Sigma_{nm}^<(E)) + i\mathcal{P} \int \frac{dE'}{2\pi} \frac{\Sigma_{nm}^>(E') - \Sigma_{nm}^<(E')}{E - E'}, \quad (3)$$

$$\mathbf{G}_{nm}^A(E) = \mathbf{G}_{mn}^{R\dagger}(E). \quad (4)$$

The indices  $l$ ,  $m$ , and  $n$  refer to the atomic positions  $\mathbf{R}_l$ ,  $\mathbf{R}_m$ , and  $\mathbf{R}_n$ , respectively. The matrices  $\mathbf{E}$  (diagonal, injection energy),  $\mathbf{E}_n$  (diagonal, on-site energy),  $\mathbf{V}(\mathbf{R}_n)$  (diagonal, self-consistent electrostatic potential at position  $\mathbf{R}_n$ ),  $\mathbf{H}_{nl}$  (nearest-neighbor coupling between atom  $n$  and  $l$ ),  $\Sigma_{nl}^B(E)$  (boundary self-energy, different from 0 only if atoms  $n$  and  $l$  are directly connected to the semi-infinite device contacts, computed as in Ref.<sup>21</sup>),  $\Sigma_{nl}^S(E)$  (scattering self-energy between atoms  $n$  and  $l$ ), and  $\mathbf{G}_{nm}(E)$  (Green's Functions between atoms  $n$  and  $l$ ) are of size  $t_B \times t_B$ , where  $t_B$  is the number of orbitals of the tight-binding model. The formulation is general for electron and hole transport. In this work, a  $sp^3d^5s^*$  basis without spin-orbit coupling is used to describe Si<sup>50</sup> so that  $t_B=10$ . The relatively small split-off energy of Si ( $\Delta_0=45$  meV) justifies the neglect of spin-orbit coupling when only electron transport is considered as here. Each atom composing the simulation domain is treated individually. In Eq. 3,  $\mathcal{P}$  denotes the Cauchy principal integral value. The definition and interpretation of the on-site energy  $\mathbf{E}_n$  and nearest-neighbor coupling matrix  $\mathbf{H}_{nl}$  can be found in Ref.<sup>48–50</sup>.

The nearest-neighbor connection  $\mathbf{H}_{nl}$  depends on the relative position of the atoms  $n$  and  $l$ , i. e. it is a function of  $\mathbf{R}_l - \mathbf{R}_n$ . If lattice vibrations are neglected, the positions of the atoms are fixed and time-independent, so that  $\mathbf{R}_n(t) = \mathbf{R}_n^0$ . When the lattice starts to vibrate the atoms oscillate around their equilibrium position  $\mathbf{R}_n^0$  with an amplitude  $\mu_n(t)$  and

$$\mathbf{R}_n(t) = \mathbf{R}_n^0 + \mu_n(t). \quad (5)$$

This implies that  $\mathbf{H}_{nl}$  becomes a function of  $(\mathbf{R}_l^0 - \mathbf{R}_n^0) + (\mu_l(t) - \mu_n(t))$  and that it can be expanded around its equilibrium position to lowest order in  $(\mu_l(t) - \mu_n(t))$

$$\begin{aligned} \mathbf{H}_{nl} &\approx \mathbf{H}_{nl}^0 + \sum_i \frac{\delta \mathbf{H}_{nl}}{\delta (R_{l,i}^0 - R_{n,i}^0)} \cdot (\mu_l^i(t) - \mu_n^i(t)) \\ &\approx \mathbf{H}_{nl}^0 + \sum_i \nabla_i \mathbf{H}_{nl} \cdot (\mu_l^i(t) - \mu_n^i(t)). \end{aligned} \quad (6)$$

The index  $i$  runs over the  $x$ ,  $y$ , and  $z$  directions. In Eq. 6 the lattice vibrations are approximated as harmonic oscillations. The second, time-dependent term in Eq. 6 is assumed much smaller than  $\mathbf{H}_{nl}^0$  and is treated in a perturbative way, leading to the electron-phonon scattering self-energies<sup>35–37</sup>.

In the second quantization picture the harmonic oscillations  $\mu_l^i(t)$  are given by<sup>43,44</sup>

$$\mu_l^i(t) = \sum_{\lambda, \mathbf{q}} \sqrt{\frac{\hbar}{2M_l \omega_\lambda(\mathbf{q})}} \cdot f_\lambda^i(\mathbf{R}_l, \mathbf{q}) \cdot (a_\lambda^\dagger(-\mathbf{q}, t) + a_\lambda(\mathbf{q}, t)), \quad (7)$$

where the indices  $\lambda$  and  $\mathbf{q}$  depict the oscillator mode and wave vector, respectively,  $M_l$  is the mass of the atom at position  $\mathbf{R}_l$ , while the operator  $a_\lambda^\dagger(-\mathbf{q}, t)$  ( $a_\lambda(\mathbf{q}, t)$ ) creates (annihilates) a phonon in mode  $\lambda$  and momentum  $\mathbf{q}$ . The normalized atomic displacement  $f_\lambda^i(\mathbf{R}_l, \mathbf{q})$  and the phonon frequency  $\omega_\lambda(\mathbf{q})$  are calculated from the following harmonic oscillator eigenvalue problem<sup>51</sup>

$$\sum_{m,j} \frac{\Phi_{nm}^{ij}(\mathbf{q})}{\sqrt{M_n M_m}} \cdot f_\lambda^j(\mathbf{R}_m, \mathbf{q}) - \omega_\lambda^2(\mathbf{q}) \cdot f_\lambda^i(\mathbf{R}_n, \mathbf{q}) = 0. \quad (8)$$

The dynamical matrix  $\Phi_{nm}^{ij}(\mathbf{q})$  depends on the geometry of the device structure and determines the nature of the phonons (bulk, 1-D, 2-D, or 3-D confined phonons).

Starting from the definition of the electron-phonon Hamiltonian in Eq. 6 and using functional derivatives<sup>45–47</sup> the general form of the two-time-dependent electron-phonon self-

energy  $\Sigma_{nm}^{e-ph}(tt')$  in the self-consistent Born approximation is obtained as

$$\Sigma_{nm}^{e-ph}(tt') = i\hbar \sum_{l_1 l_2} \sum_{\lambda, \mathbf{q}} \mathbf{M}_{nl_1}^{\lambda}(\mathbf{q}) \cdot \mathbf{G}_{l_1 l_2}(tt') \cdot \mathbf{M}_{l_2 m}^{\lambda*}(\mathbf{q}) \cdot \mathcal{D}^{\lambda}(\mathbf{q}; tt'), \quad (9)$$

$$\mathbf{M}_{nm}^{\lambda}(\mathbf{q}) = \sqrt{\frac{\hbar}{2\omega_{\lambda}(\mathbf{q})}} \sum_i \nabla_i \mathbf{H}_{nm} \cdot \left( \frac{f_{\lambda}^i(\mathbf{R}_m, \mathbf{q})}{\sqrt{M_m}} - \frac{f_{\lambda}^i(\mathbf{R}_n, \mathbf{q})}{\sqrt{M_n}} \right) \quad (10)$$

The phonon Green's Function  $\mathcal{D}^{\lambda}(\mathbf{q}; tt')$  is defined as in Ref.<sup>44</sup>. To derive Eq. 9 the property that  $f_{\lambda}^i(\mathbf{R}_n, -\mathbf{q}) = f_{\lambda}^{i*}(\mathbf{R}_n, \mathbf{q})$  has been applied. Equation 9 is valid in 3-D structures only where electrons are confined along two directions ( $y$  and  $z$ ) and transport occurs along the third one ( $x$ ), like nanowires. In this configuration, the Green's Functions  $\mathbf{G}_{nm}(tt')$  have no momentum dependence, in contrary to the phonons.

Langreth theorem<sup>41</sup>, the replacement of the phonon Green's Function by its unperturbed definition at equilibrium<sup>44</sup>, and the consideration of the steady-state regime allow one to find the energy-dependent self-energy  $\Sigma_{nm}^{\geq, e-ph}(E)$

$$\Sigma_{nm}^{\geq, e-ph}(E) = \sum_{l_1 l_2} \sum_{\lambda, \mathbf{q}} \mathbf{M}_{nl_1}^{\lambda}(\mathbf{q}) \cdot \left[ N^{\lambda}(\mathbf{q}) \mathbf{G}_{l_1 l_2}^{\geq}(E \pm \hbar\omega_{\lambda}(\mathbf{q})) + (N^{\lambda}(\mathbf{q}) + 1) \mathbf{G}_{l_1 l_2}^{\geq}(E \mp \hbar\omega_{\lambda}(\mathbf{q})) \right] \cdot \mathbf{M}_{l_2 m}^{\lambda*}(\mathbf{q}), \quad (11)$$

where  $N^{\lambda}(\mathbf{q})$  is the Bose distribution of the phonons with frequency  $\omega_{\lambda}(\mathbf{q})$ . In 3-D simulation domains, Eq. 1 to 4 and 11 cannot be directly solved and require further approximations. In a small nanowire structure with  $N_A=10,000$  atoms, the total size of the Green's Function and of the self-energy matrices is  $N_A \times t_B=100,000$  in the  $sp^3d^5s^*$  tight-binding model without spin-orbit coupling. Inverting, factorizing, and multiplying such full matrices for multiple energies goes beyond the capabilities of currently available supercomputers.

## B. Simplifications and Approximations

To investigate realistic nanowire structures with electron-phonon scattering some simplifications and/or approximations have to be considered in the calculation of the Green's Functions, the self-energies, and the dispersion relation of phonons.

The dynamical matrix  $\Phi_{nm}^{ij}(\mathbf{q})$  in Eq. 8 is based on a modified Keating model including four terms (bond stretching, bond bending, angle-angle, and bond-bond interactions)<sup>52</sup>. This model uses four material constants that are optimized to accurately reproduce the bulk

phonon dispersion of different semiconductors like Si or Ge. The original bulk formalism has been first verified and then extended to calculate the confined phonon modes of nanowires, similarly to Ref.<sup>53,54</sup>, automatically accounting for the acoustic and the optical phonon branches. For that purpose, the nanowire structure is assumed to be infinite and composed of identical unit cells. The 3-D wave vector  $\mathbf{q}$  reduces to its single  $x$ -component  $q$  aligned with the NW transport direction. As a second approximation, the environment of the nanowires (dielectric layers, substrate, metallic gate) is omitted in the computation of the phonon bandstructure and eigenmodes. The surface atoms are therefore free to move. Discussions about the influence of the boundary conditions on the calculation of the phonon spectra can be found in Ref.<sup>53–55</sup>.

To minimize the required memory to store the Green's Functions and the self-energies as well as to reduce the computational burden, the  $\Sigma_{nm}^{e-ph}(\mathbf{E})$  are limited to on-site interactions only, i. e.  $n=m$ , but remain  $t_B \times t_B$  blocks. There is no physical justification to this approximation, but it appears to be the only way to numerically treat 3-D structures like nanowires composed of more than a dozen of atoms. Each additional connection to more distant neighbors (nearest, second-nearest, third-nearest, ...) induces an exponential increase of the time to compute the self-energy in Eq. 11. Furthermore, a large number of the off-diagonal blocks  $\mathbf{G}_{nm}(\mathbf{E})$  must be computed if off-site self-energy interactions are taken into account. Efficient computational approaches like the recursive Green's Function (RGF) algorithm<sup>64</sup> fail if far off-diagonal blocks are required. The physical implications of full-matrix and diagonal self-energy interactions have recently been studied in small 2-D systems with respect to the influence on phase and momentum relaxation<sup>56</sup>. To compensate the missing self-energy terms, the magnitude of the matrix elements  $\mathbf{M}_{nm}^\lambda(\mathbf{q})$  can be artificially increased<sup>57</sup>. This has not been tested in this study and it can only be speculated that scattering is underestimated.

To avoid the calculation of several off-diagonal blocks  $\mathbf{G}_{nm}$  and to ensure current conservation in the diagonal self-energy approximation, Eq. 11 is simplified to

$$\Sigma_{nn}^{\gtrless, e-ph}(E) = \sum_l \sum_{\lambda, q} \mathbf{M}_{nl}^\lambda(q) \cdot \left[ N^\lambda(q) \mathbf{G}_l^{\gtrless}(E \pm \hbar\omega_\lambda(q)) + \right. \\ \left. (N^\lambda(q) + 1) \mathbf{G}_l^{\gtrless}(E \mp \hbar\omega_\lambda(q)) \right] \cdot \mathbf{M}_{ln}^{\lambda*}(q). \quad (12)$$

The position index  $l$  runs over all the nearest-neighbors of the atom located at  $\mathbf{R}_n$ , generally



four atoms, except at the nanowire surface. A combination like  $\mathbf{M}_{nl_1} \cdot \mathbf{G}_{l_1 l_2}(E) \cdot \mathbf{M}_{l_2 n}$  where  $l_1$  and  $l_2$  are two different nearest-neighbors of  $n$  is technically possible, but it would break current conservation if a self-energy of the form  $\Sigma_{l_1 l_2}(E)$  (off-site connection) does not exist. However, for computational reasons such self-energies are neglected as mentioned above.

While the electron-phonon interaction has been made local in space in Eq. 12, it remains non-local (inelastic) in energy, one energy  $E$  being coupled to many other energies  $E' = E \pm \hbar\omega_\lambda(q)$ . In a typical nanowire structure, the number of phonon modes  $\lambda$  exceeds one hundred and the phonon 1-D Brillouin Zone needs to be described by about 50  $q$  points. Hence, one energy point is connected to at least  $2 \cdot 100 \cdot 50 = 10,000$  other points (the factor 2 comes from the plus and minus sign in  $\pm \hbar\omega_\lambda(q)$ ). This results in several numerical problems. First, this number is larger than the total number of points in the energy grid ( $N_E = 1,500$  to 2,000). Secondly, since the energy points are distributed over many CPUs (see Appendix A), too much inter-processor communication would be required to exchange massive Green's Function data, which is not recommended in parallel computing. An approximate solution to this problem has been developed and implemented. If the sum over the phonon momentum vector  $q$  is replaced by an integration over the phonon 1-D Brillouin Zone (BZ) of length  $L_{BZ}$ , the schematic form of the electron-phonon self-energy is given by

$$\begin{aligned} \Sigma_{nn}^{e-ph}(E) &\propto \sum_{l,\lambda,q} \sum_{ij} \nabla_i \mathbf{H}_{nl} \cdot \mathbf{G}_{ll}(E \pm \hbar\omega_\lambda(q)) \cdot \nabla_j \mathbf{H}_{ln} \cdot \\ &\quad \underbrace{\frac{\hbar}{2\omega_\lambda(q)} \cdot \left( \frac{f_\lambda^i(\mathbf{R}_l, q)}{\sqrt{M_l}} - \frac{f_\lambda^i(\mathbf{R}_n, q)}{\sqrt{M_n}} \right) \cdot \left( \frac{f_\lambda^{j*}(\mathbf{R}_n, q)}{\sqrt{M_n}} - \frac{f_\lambda^{j*}(\mathbf{R}_l, q)}{\sqrt{M_l}} \right)}_{\mathbf{V}_{nlln}^{ij}(\omega_\lambda(q))} \\ &\propto \sum_{l,\lambda} \sum_{ij} \int_{BZ} \frac{dq}{L_{BZ}} \mathbf{V}_{nlln}^{ij}(\omega_\lambda(q)) \cdot \nabla_i \mathbf{H}_{nl} \cdot \mathbf{G}_{ll}(E \pm \hbar\omega_\lambda(q)) \cdot \nabla_j \mathbf{H}_{ln}. \quad (13) \end{aligned}$$

The coupling strength factor  $\mathbf{V}_{nlln}^{ij}(\omega_\lambda(q))$  has been introduced to clarify the notation, but the multiple energy connections remain. To reduce them, it is assumed that the lesser and greater Green's Functions  $\mathbf{G}_{ll}^{\gtrless}(E)$  slowly vary over a small energy range  $E - \Delta_E \leq E \leq E + \Delta_E$  in the presence of electron-phonon scattering. This is the case for most of the energy points. Then the sum over  $\lambda$  and the integration over  $q$  are replaced by a sum over the phonon

energy  $\omega_{PH}$

$$\begin{aligned} \Sigma_{nn}^{\geq e-ph}(E) = \sum_{l,i,j} \sum_{\omega_{PH}} \mathcal{V}_{nlln}^{ij}(\omega_{PH}) \cdot \nabla_i \mathbf{H}_{nl} \cdot \left( N^{PH}(\omega_{PH}) \cdot \mathbf{G}_{ll}^{\geq}(E \pm \hbar\omega_{PH}) + \right. \\ \left. (N^{PH}(\omega_{PH}) + 1) \cdot \mathbf{G}_{ll}^{\geq}(E \mp \hbar\omega_{PH}) \right) \cdot \nabla_j \mathbf{H}_{ln} \end{aligned} \quad (14)$$

$$\mathcal{V}_{nlln}^{ij}(\omega_{PH}) = \sum_{\lambda} \int_{BZ} \frac{dq}{L_{BZ}} \mathbf{V}_{nlln}^{ij}(\omega_{\lambda}(q)) \Big|_{\omega_{PH}-\Delta_E/\hbar \leq \omega_{\lambda}(q) \leq \omega_{PH}+\Delta_E/\hbar}. \quad (15)$$

The sum over  $\lambda$  and  $q$  does not completely disappear, but it is moved into the coupling factor  $\mathcal{V}_{nlln}^{ij}(\omega_{PH})$  that is pre-computed at the beginning of any new simulation. It has been numerically verified that a value  $\Delta_E=1$  meV is small enough to ensure accurate results and that increasing the number of  $\omega_{PH}$  points, i.e. decreasing the value of  $\Delta_E$  below 1 meV, does not significantly change the results any more, but slows down the computation time. Values of  $\Delta_E$  comprised between 0.25 and 2 meV have been tested resulting in a variation of the device current by less than 5%. In Si the largest phonon energy amounts to approximately 60 meV so that the sum over  $\omega_{PH}$  can be restricted to  $2 \times 30$  points instead of 10,000 if  $\Delta_E=1$  meV is assumed.

In Eq. 3, the retarded self-energy  $\Sigma_{nn}^R(E)$  is composed of two parts, the second one requiring the evaluation of a Cauchy principal integral coupling all the energies together. For the same computational reasons as above, this integral term cannot be calculated and it is therefore neglected in this paper. Previous studies have showed that this simplification does not introduce significant errors in the calculation of the device current<sup>28,58</sup>. As a future improvement, the retarded self-energy  $\Sigma_{nn}^R(E)$  will be derived directly from Eq. 9 following the same procedure as for the lesser and greater  $\Sigma_{nn}^{\geq}(E)$  terms.

Finally, the nearest-neighbor matrix elements of the Slater-Koster table<sup>48</sup> are derived to obtain the  $\nabla_i \mathbf{H}_{nm}$  in Eq. 14. Only the relative angle dependence of each atom with respect to its neighbors (the  $l$ ,  $m$ , and  $n$  directional cosines) is considered to calculate  $\nabla_i \mathbf{H}_{nm}$ , not the distance (bond length) dependence of the matrix elements. The latter requires that the matrix elements  $\mathbf{H}_{nm}$  are scaled by a factor  $(d_0/d)^\eta$ , where  $d_0$  ( $d$ ) is the ideal (altered) bond length<sup>49</sup>. If the bond length dependence is included, the  $\nabla_i \mathbf{H}_{nm}$  terms increase, as the electron-phonon interaction, leading to a decrease of the device current. Despite the overestimation of the device current the bond length dependence of  $\mathbf{H}_{nm}$  is neglected since the  $\eta$  values for Si do not appear to be unequivocally defined in the literature<sup>49,59,60</sup>.

### C. Convergence Criteria

Equations 1 to 4 and 14 are self-consistently solved till convergence is reached. A parallel recursive Green's Function (RGF) algorithm (up to 4 CPUs) has been developed to accomplish this task as explained in Appendix A. Two criteria are used to check the convergence of the self-consistent Born treatment of the Green's Functions and self-energies. The successive iterations of Eq. 1 to 4 and 14 are stopped when the carrier and the current densities, calculated as in Ref.<sup>61,62</sup> vary within an error of 1‰ and 1%, respectively.

Especially, in a two-terminal device (source and drain), current conservation implies that the current that enters the simulation domain at a port  $B_1$  is the same as the current that leaves the structure at the other port  $B_2$

$$I_d(B) = \frac{e}{\hbar} \sum_{\text{spin}} \sum_{nm} \int \frac{dE}{2\pi} \text{tr} (\Sigma_{nm}^{>B}(E) \cdot \mathbf{G}_{mn}^{<}(E) - \mathbf{G}_{nm}^{>}(E) \cdot \Sigma_{mn}^{<B}(E)). \quad (16)$$

The current  $I_d(B)$  is the current at the terminal  $B \in (\text{source}, \text{drain})$ , the position indices  $n$  and  $m$  run over all the atoms directly connected to the semi-infinite device contact  $B$ , while  $\Sigma_{nm}^{>B}$  and  $\Sigma_{nm}^{<B}$  are the boundary self-energies at the port  $B$ . The trace operator “tr” runs over the different orbitals of the atoms  $n$  and  $m$ . The convergence criterion for the current becomes then  $I_d(\text{drain})=I_d(\text{source})$ . As a part of data post-processing, it can be checked that indeed current is conserved throughout the device from one layer to the other.

Surrounding the self-consistent Born iterations between the Green's Functions and the self-energies, there is the self-consistent coupling of the charge density and of the device electrostatic potential through Poisson equation<sup>40</sup>. Generally, the carrier density converges much faster than the current density (about 5 to 10 self-consistent Born iterations vs 20 to 50 for the current). Consequently, as long as the electrostatic potential is not stable, only the convergence of the charge density is fulfilled. Once that Poisson equation has converged, the criterion for the current density is satisfied too.

### III. RESULTS

The structure of the Si gate-all-around (GAA) nanowire field-effect transistors considered in this work is depicted in Fig. 1. The diameter of the NWs is varied from 2 to 3 nm, the gate length  $L_g$  is set to 15 nm, while the  $n$ -doped ( $N_D=1\text{e}20 \text{ cm}^{-3}$ ) source and drain extensions

measure 12.5 nm, except for the nanowire with  $d=2.5$  nm, where they are extended to 15 nm. Hence, the structure with  $d=2$  nm is composed of 6,497 atoms, that with  $d=2.5$  nm of 11,371 atoms, and finally that with  $d=3$  nm of 14,089 atoms. In the  $sp^3d^5s^*$  tight-binding formalism without spin-orbit coupling, the  $d=3$  nm NW is represented by an Hamiltonian matrix of size  $N=140,890$ .

The drain current  $I_d$  flows along the  $x$  direction of the NW FETs, which is aligned with the  $\langle 100 \rangle$  crystal axis,  $y$  and  $z$  are directions of confinement. The nanowire channel is isolated from the coaxial metal gate contact (work function  $\phi_M=4.05$  eV) by a  $\text{SiO}_2$  oxide layer of thickness  $t_{ox}=1$  nm, characterized by a relative dielectric constant  $\epsilon_R=3.9$ , and assumed ideal (infinite band gap). The mechanical coupling between the nanowires and their environment is not taken into account in the simulations so that the transistors can be seen as free standing. All the simulations are performed at room temperature.

The density-of-states (DOS)  $g(E)$  of the phonon modes confined in the free-standing Si nanowire with  $d=2.5$  nm is reported in Fig. 2. The inset represents the lowest acoustic bands of the phonon dispersion  $E^{PH}(q)$  used to calculate  $g(E)$

$$g(E) = \frac{1}{V_{uc}} \sum_q \delta(E - E^{PH}(q)), \quad (17)$$

where  $V_{uc}$  is the volume of a nanowire unit cell. The phonon DOS exhibits several peaks, especially around  $E=15$ -16 meV and around  $E=58$ -59 meV which is the energy of the optical phonons in bulk Si. This means that the electron-phonon interaction around these energies is stronger and the probability for an electron or hole to absorb or emit a phonon with these energies is higher.

The transfer characteristics  $I_d - V_{gs}$  at  $V_{ds}=0.6$  V of Si GAA NW FETs with diameters  $d=2, 2.5$ , and 3 nm are shown in Fig. 3 to 5. The dashed gray lines with circles refer to ballistic transport simulations, the black lines with squares to simulations in the presence of electron-phonon scattering. The drain currents  $I_d$  are given on a logarithmic (left axis) and on a linear (right axis) scale.

The current reduction due to electron-phonon scattering is reported in Fig. 6 for the three nanowire FETs as function of  $V_{gs}$  and at  $V_{ds}=0.6$ . It is defined as  $(I_{ball} - I_{scatt})/I_{ball} * 100$ , where  $I_{ball}$  and  $I_{scatt}$  are the ballistic and the dissipative currents, respectively. The arrows indicate the position of the transistor threshold voltage in the ballistic simulations. As shown in Fig. 3 to 5, the threshold voltage of the nanowire devices depends on the transport

model, ballistic or dissipative, resulting in a short saturation region of the current reduction starting at the arrow positions.

In Fig. 7 the output characteristics  $I_d - V_{ds}$  of the nanowire with  $d=2$  nm with (solid line with squares) and without (dashed line with circles) electron-phonon scattering are compared at  $V_{gs}=0.5$  V. The current reduction due to scattering  $(I_{ball} - I_{scatt})/I_{ball} * 100$  is also given on the right  $y$ -axis. It varies by less than 4% from  $V_{ds}=0.05$  V to  $V_{ds}=0.6$  V. From Fig. 3 to 7, three common characteristics shared by all the device are identified, (i) the ballistic current is larger than the current with scattering, (ii) the difference between the two currents becomes larger at high  $V_{gs}$ , and (iii) the inclusion of scattering helps the convergence of the Poisson equation up to higher  $V_{gs}$ . Each of these points is detailed below.

Electron-phonon scattering modifies the electrostatic potential of the NW FETs as illustrated in Fig. 8. In the source extension ( $0 \leq x \leq 15$ ), the total number of electrons  $n_{tot}$  is composed of forwards ( $n_F$ ) and backwards ( $n_B$ ) moving charges. The forward moving charges are those injected at the source contact while the backward moving charges are those reflected back to the source contact or coming from the drain contact. At low gate biases ( $V_{gs}$ )  $n_F$  and  $n_B$  have almost the same magnitude, the doping concentration  $N_D$  divided by 2, most of the injected electrons being reflected at the source-to-drain potential barrier ( $\rightarrow n_B=n_F$ ), and charge neutrality being imposed by Poisson equation ( $\rightarrow n_{tot}=n_F+n_B=N_D$ ). The fundamental difference between the ballistic current and the current with scattering comes from the possibility for electrons flowing over the source-to-drain potential barrier to interact with a phonon and to be reflected back to the source. This effect reduces the current magnitude, but it is no more important if it occurs after a distance  $l$  measured from the top of the potential barrier and called critical length for backscattering<sup>65</sup>. After this distance an electron interacting with a phonon has a very low probability to flow back to the source contact.

At  $V_{gs}=0.1$  V, the ballistic current ( $I_{ballistic}$ ) exceeds the current with scattering ( $I_{scattering}$ ) by a factor of 1.86 for a NW diameter with  $d=2$  nm, 1.52 for  $d=2.5$  nm, and 1.35 for  $d=3$  nm. At  $V_{gs}=0.5$  V the difference between the two currents increases to 1.98 ( $d=2$  nm), 2.0 ( $d=2.5$  nm), and 1.63 ( $d=3$  nm). The fact that electron-phonon plays a more important role in NWs with a small diameter tends to confirm the observation made in Ref.<sup>10</sup>.

The behavior of the electrostatic potential in the unrealistic ballistic transport regime is the main reason behind the current increase close to the transistor ON-state ( $V_{ds}=V_{gs}=0.6$  V). The lowering of the source-to-drain potential barrier, as observed in Fig. 8 at  $V_{gs}=0.5$

$V$ , reduces the amount of reflected electrons  $n_B$  to almost 0. To maintain charge neutrality in the source contact, the number of injected electrons  $n_F$  is artificially increased to the value of the donor concentration  $N_D$  by pushing down the conduction band edge, but the total number of electrons in the source  $n_{tot}=n_F+n_B$  remains the same and is equal to  $N_D$  as illustrated in Fig. 9.

Since the ballistic current is directly proportional to the number of injected electrons at the source, it increases with  $n_F$ . When electron-phonon is switched on, some of the electrons injected at the source contact are reflected back when they absorb or emit a phonon so that  $n_B$  does not completely vanish. It remains smaller than  $n_F$ , but the conduction band edge does not need to move down as deep as in the ballistic simulations. The conjunction of the backscattering effect and of the conduction band shift explains the larger difference between the ballistic and scattering currents at high  $V_{gs}$ .

To determine the ballisticity  $B=I_{scattering}/I_{ballistic}$  of the Si nanowire FETs, the effect of the artificial lowering of the conduction band edge must be removed from  $I_{ballistic}$ . This is achieved by recalculating the ballistic current using the electrostatic potential obtained in the presence of electron-phonon scattering. Then, the only difference between  $I_{ballistic}$  and  $I_{scattering}$  arises from the backscattering mechanism<sup>65</sup> and not from unphysical artifacts. In doing so, at  $V_{gs}=0.5$  V,  $I_{ballistic}$  becomes larger than  $I_{scattering}$  by a factor of 2.0 for the NW with  $d=2$  nm, 1.56 for  $d=2.5$  nm, and 1.42 for  $d=3$  nm, which is comparable to the results obtained at  $V_{gs}=0.1$  V (1.86, 1.52, and 1.35) and smaller than the values obtained in the pure ballistic simulations with the lowering of the CB edge (2.13, 2.0, and 1.63). Hence, one obtains  $B_{2nm}=50\%$ ,  $B_{2.5nm}=64\%$ , and  $B_{3nm}=70\%$ . The inclusion of interface roughness at the Si-SiO<sub>2</sub> interface will probably reduce the ballisticity of the FETs<sup>66</sup>.

For gate voltage  $V_{gs}$  beyond 0.5 V, (0.6 V for the nanowire with  $d=2$  nm), the Poisson equation does not converge anymore in the ballistic simulations. The mechanism that pushes down the conduction band, as explained above, becomes very sensitive to a small variation of the electrostatic potential which in turn starts to oscillate in the source extension region. The inclusion of dissipative scattering resolves this issue. At high  $V_{gs}$ , the transistor acts as a resistor, the electrostatic potential drops in the source and drain regions, as seen in Fig. 8, and the emission of phonons allows the electrons to fill energy states located below the conduction band edge of the semi-infinite source contact. These states are inaccessible in the absence of dissipative scattering. Hence, the electrostatic potential remains stable

and the self-consistent calculation of the electron density and of Poisson equation continues to converge.

Figure 10 shows the ballistic and scattering currents at  $V_{gs}=0.5$  V and  $V_{ds}=0.6$  V as function of the position and energy in the NW FET with  $d=2.5$  nm. The ballistic current is conserved for each injection energy  $E$ , as expected, while the current with electron-phonon scattering follows the contour of the electrostatic potential, it flows at higher energy in the source than in the drain region due to phonon emission, and only the sum of the current contributions from all the energies is conserved. Current conservation in the presence of electron-phonon scattering is demonstrated in Fig. 11.

The ON-current ( $I_d$  at  $V_{gs}=V_{ds}=0.6$  V) of the NW FET with  $d=2.5$  nm is given in Fig. 12. The potential drop in the source region is larger than at  $V_{gs}=0.5$  V in Fig. 10 and regions with a high current concentration (indicated by black arrows) separated by regions with a lower current concentration become visible. The energy separation between these regions is about 15-16 meV, corresponding to one of the peaks of the phonon density-of-states shown in Fig. 2. The phonon DOS is larger at 58-59 meV than at 15-16 meV, but since the electron-phonon coupling factor  $\mathcal{V}_{nlln}^{ij}(\omega_{PH})$  in Eq. 14 is inversely proportional to the phonon frequency  $\omega_{PH}$ , the strength of the electron-phonon interaction at  $E=15-16$  meV is almost 4 times larger than at 58-59 meV. This explains the energy separation of the regions with a high current concentration.

#### IV. CONCLUSION AND OUTLOOK

Electron-phonon scattering has been demonstrated in a 3-D, atomistic, full-band, device simulator based on the nearest-neighbor  $sp^3d^5s^*$  tight-binding model and the Non-equilibrium Green's Function formalism. Nanowire field-effect transistors with a diameter up to 3 nm, a length of 40 nm, and composed of more than 14,000 atoms have been simulated. The influence of electron-phonon scattering in the OFF- and ON-states of Si NW transistors is investigated. The overestimation of the drain current by ballistic transport simulations is more pronounced in the ON-state due to an increase of the electrons that are injected at the source contact.

To further extend the dimensions of the 3-D simulation domains, the numerical algorithm must be improved. The current parallelization of the recursive Green's Function (RGF)

algorithm does not allow to distribute the work load over a large enough number of CPUs. More efficient approaches have been proposed by other groups<sup>67,68</sup> and will be tested in the future.

The capability of treating electron-phonon scattering will be of great interest to study certain types of devices like band-to-band tunneling field-effect transistors (TFETs) which are based on the tunneling of electrons from the valence band of one contact into the conduction band of the other contact. Silicon might be the material of choice to fabricate such devices because it is compatible with the MOSFET technology and its properties are well-understood. However, the indirect band gap of Si prevents direct tunneling to occur between its valence band and its conduction band. Momentum conservation requires that a phonon is absorbed or emitted during the tunneling process. At the same time, modeling TFETs demands a full-band approach to accurately describe the valence and conduction bands of the semiconductor material.

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### **APPENDIX A: NUMERICAL IMPLEMENTATION**

Parallel computing is the key element to solve Eq. 1 to 4 and 14 in 3-D nanowire structures. It would simply not be possible to simulate the devices described in Section III on a single processor, not even on a small cluster of 100 cores or less. All the results presented in this work were obtained on 3,200 to 6,400 cores and each simulation lasted between 36 and 100 hours, depending on the device dimensions.



Due to the energy coupling no embarrassingly parallelization of Eq. 14 is possible. To keep an efficient distribution of the energy points (ideally, there are  $N_{E,local}=2$  energy points per CPU) the calculation of Eq. 1 to 4 and 14 is separated in two steps:

1. for each new self-consistent Born iteration, all the  $\Sigma_{nn}^{<e-ph}(E)$  and  $\Sigma_{nn}^{>e-ph}(E)$  are first computed from Eq. 14. This requires a lot of communication since each energy point  $E$  needs about  $2*30*N_A \mathbf{G}_{nn}^{\geq}(E')$  blocks from the previous self-consistent Born iteration. The factor 2 originates from the connection to higher and lower energies  $E'$ , 30 is the number of different phonon energies that are typically considered, while  $N_A$  is the number of atoms in the device structure. The  $N_A$  blocks  $\mathbf{G}_{nn}^{\geq}(E')$  of size  $t_B \times t_B$  are cast into a single variable  $\mathcal{G}^{\geq}(E')$  of size  $N_A t_B \times t_B$  and are not individually transferred from one CPU to the other, but in one single step. Each of the 60  $\mathcal{G}^{\geq}(E')$  matrices are usually stored on 60 different CPUs. In other words, each core must send its Green's Functions to 60 different CPUs and receive data from 60 others. The most efficient solution to manage the communication issues consists in using the non-blocking MPI\_Isend function to send the data and MPI\_Receive to collect them<sup>63</sup>. For a given phonon energy  $\omega_{PH}$ , each CPU sends its  $N_{E,local} \mathcal{G}^{\geq}(E)$  matrices to the CPU(s) containing the energies  $E \pm \hbar\omega_{PH}$ . After all the CPUs have sent their data, they can at any time receive the matrices  $\mathcal{G}^{\geq}(E \mp \hbar\omega_{PH})$  they need to evaluate Eq. 14 for the  $N_{E,local}$  energy points they take care of.
2. once that each CPU has solved Eq. 14, Eq. 1 to 4 can be computed in an almost embarrassingly parallel way, with limited interprocessor communication, as described in Ref.<sup>40</sup>.

For a typical energy grid of  $N_E=1,500-2,000$  energy points, a total number of 750 to 1,000 CPUs can be used per simulation, assuming that Eq. 1 to 4 are treated on a single core using a recursive Green's function (RGF) approach<sup>64</sup>. However, the RGF algorithm can be slightly modified to efficiently parallelize on 2 CPUs. In its standard form<sup>64</sup>, the recursive calculation of the Green's Functions starts at one corner of the Hamiltonian matrix, goes on till the other corner of the matrix, and moves back to the original corner. An alternative is to start the calculation from both corners of the matrix, each of them being handled by a different CPU, to move towards the center of the matrix, to exchange information there through MPI\_Send and MPI\_Receive, and to go back to the two matrix corners. A speed-

up factor close to 2 can be obtained following this approach. Two additional cores can be used in Eq. 1 to 4, one of them calculating  $\mathbf{G}_{nn}^R(E)$  and  $\mathbf{G}_{nn}^<(E)$ , the other  $\mathbf{G}_{nn}^R(E)$  and  $\mathbf{G}_{nn}^>(E)$ . This is not an ideal parallelization since  $\mathbf{G}_{nn}^R(E)$  is calculated twice, but it allows a speed-up of 1.5. In summary, the domain decomposition of the Hamiltonian matrix and the separation of  $\mathbf{G}_{nn}^<(E)$  and  $\mathbf{G}_{nn}^>(E)$  lead to a speed-up factor of 3 on 4 cores as compared to one single CPU.

Hence, a total of 3,000 to 4,000 CPUs can be used per bias point for an energy grid of  $N_E=1,500$  to 2,000 energy points. The scaling performance of our approach for  $N_E=1,571$  points is demonstrated in Fig. 13. It is shown that the simulation time for one Born iteration (solution of Eq. 1 to 4 and Eq.14 for all the energy points) in a nanowire with a diameter of 2 nm decreases almost ideally from 28 to 3,200 cores on a CRAY XT4 machine<sup>69</sup>. The number of CPUs per energy point is set to 4 (domain decomposition and separation of  $\mathbf{G}_{nn}^<(E)$  and  $\mathbf{G}_{nn}^>(E)$ ) for all the timing experiments reported in Fig. 13. This means that 7 energy points are simultaneously treated when the total number of CPUs is equal to 28 and 800 when the total number of CPUs is 3,200. Furthermore, several bias points can be simulated at the same time in an embarrassingly parallel way. In this paper, a maximum of 2 bias points has been simultaneously treated, leading to a total number of 6,400 cores per simulation.

The scaling behavior of the simulation approach does not depend on the nanowire size or cross section and remains almost ideal for all cases. However, the simulation time increases as function of the number of atoms in the device structure. The time to solve Eq. 1 to 4 (standard RGF approach) increases as  $O(N_{CS}^3)$ , where  $N_{CS}$  is the number of atoms per nanowire unit cell<sup>21</sup> and as  $O(N_{UC})$ , where  $N_{UC}$  is the number of unit cells along the nanowire length. The time to compute the scattering self-energy in Eq. 14 linearly increases as function of the total number of atoms  $N_A$  since only diagonal interactions are considered.

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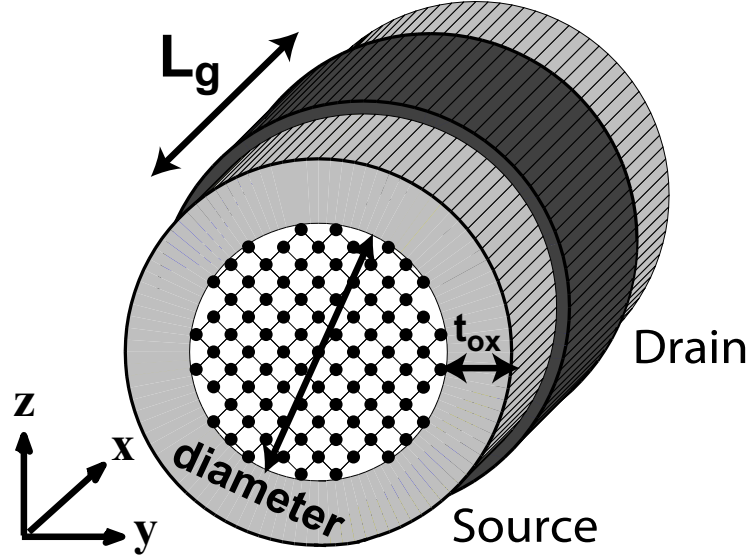


FIG. 1: Schematic view of a gate-all-around (GAA) circular Si nanowire field-effect transistor (NW FET) with a diameter  $d=2, 2.5$ , and  $3$  nm. The transport direction  $x$  is aligned with the  $\langle 100 \rangle$  crystal axis. The  $\text{SiO}_2$  dielectric layer has a thickness  $t_{ox}=1$  nm. The gate length  $L_g$  measures  $15$  nm while the source and drain contacts have a length of  $12.5$  nm and a donor doping concentration  $N_D=1\text{e}20 \text{ cm}^{-3}$ .

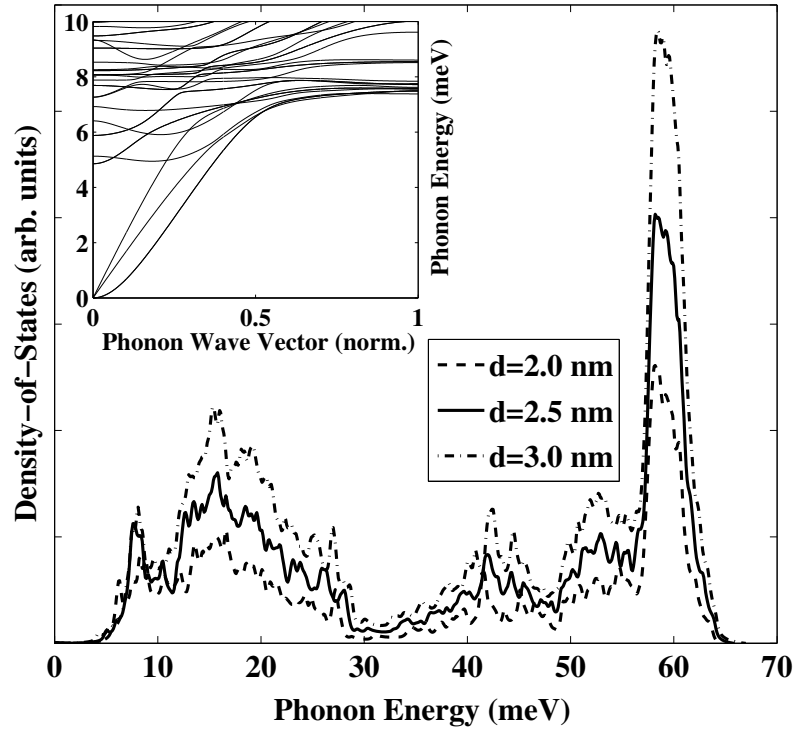


FIG. 2: Density-of-states of the confined phonons in a Si nanowire with a diameter  $d=2.0$  nm (dashed line),  $d=2.5$  nm (solid line), and  $d=3.0$  nm (dashed-dotted line). The inset shows the lowest part of the phonon bandstructure in the nanowire with  $d=2.5$  nm.



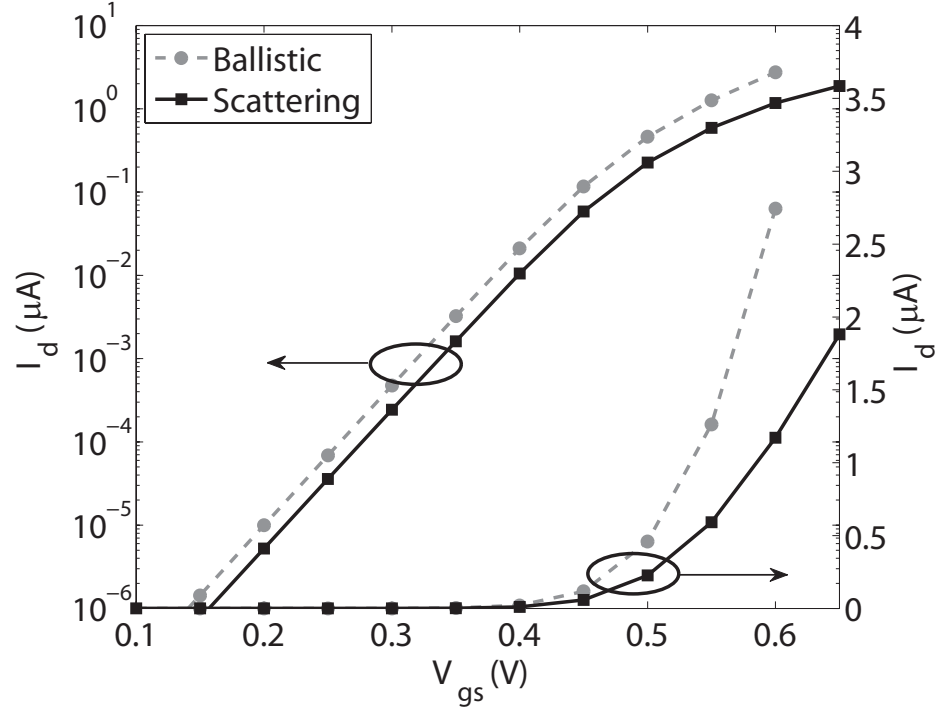


FIG. 3: Transfer characteristics  $I_d - V_{gs}$  at  $V_{ds}=0.6$  V of a Si GAA NW FET with a diameter  $d=2$  nm. The gray lines with circles refer to the ballistic current, the black lines with squares to the current with electron-phonon scattering.

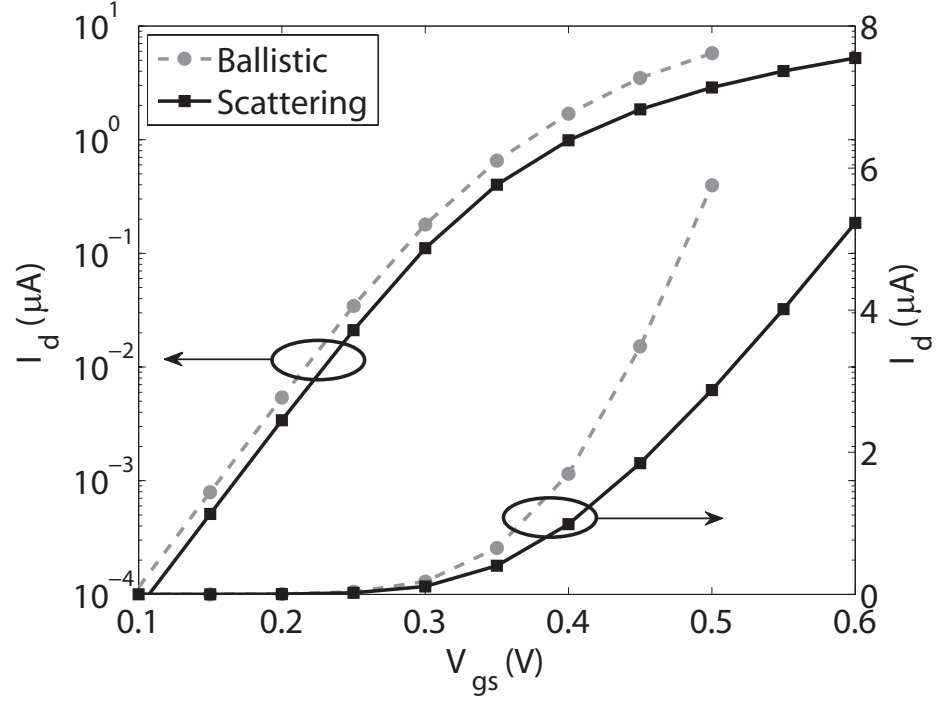


FIG. 4: Same as Fig. 3, but for a Si nanowire with a diameter  $d=2.5$  nm.

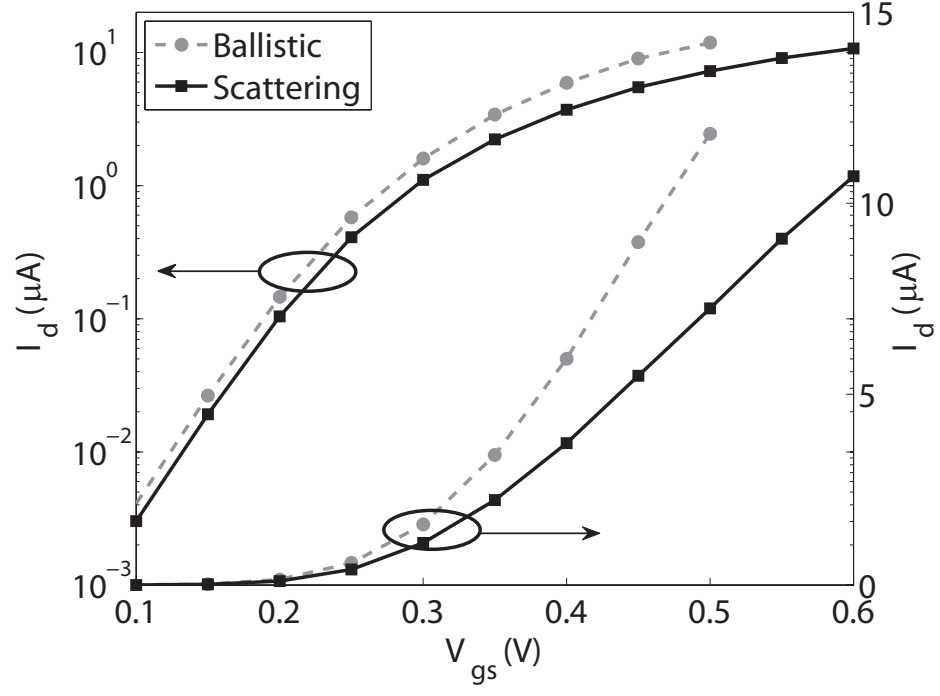


FIG. 5: Same as Fig. 3 and 4, but for a Si nanowire with a diameter  $d=3$  nm.

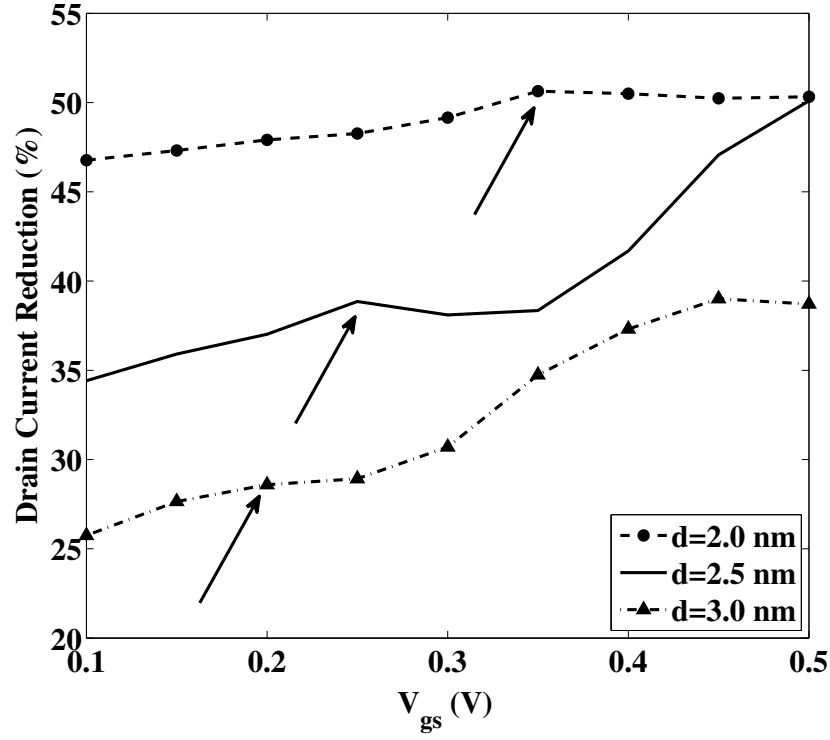


FIG. 6: Drain current reduction due to electron-phonon scattering at  $V_{ds}=0.6$  V as function of  $V_{gs}$  in Si nanowires with a diameter  $d=2.0$  nm (dashed line with circles),  $d=2.5$  nm (solid line), and  $d=3.0$  nm (dashed-dotted line with triangles). The ballistic  $I_{ball}$  and dissipative  $I_{scatt}$  currents of Fig. 3 to 5 are used to calculate  $(I_{ball}-I_{scatt})/I_{ball}*100$ . The arrows indicate the threshold voltage in the ballistic simulations.

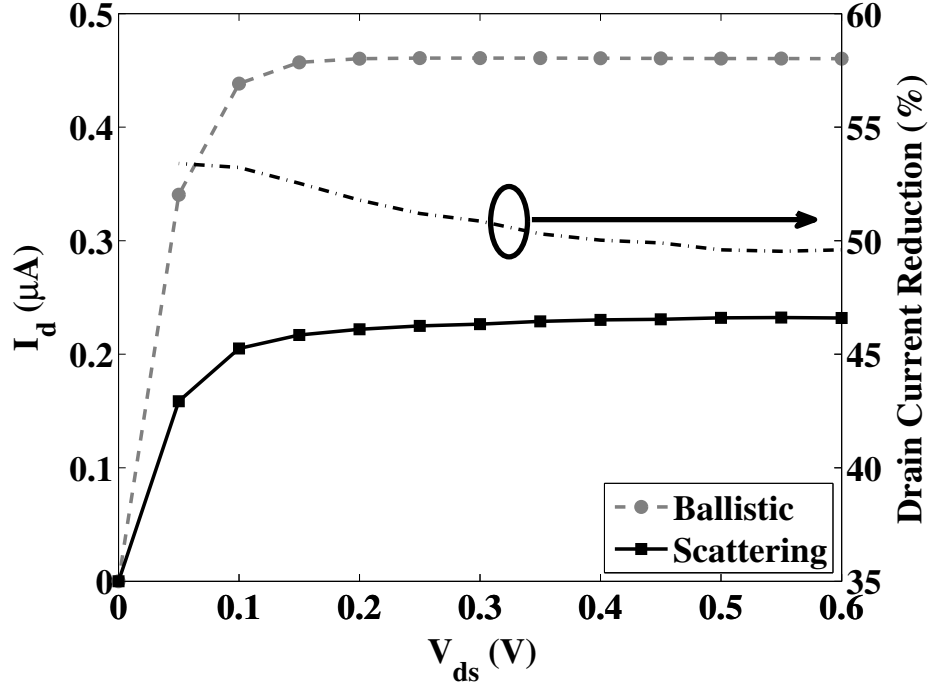


FIG. 7: Output characteristics  $I_d - V_{ds}$  at  $V_{gs}=0.5$  V (left y-axis) of the Si GAA NW FET with a diameter  $d=2$  nm. The gray lines with circles refer to the ballistic current, the black lines with squares to the current with electron-phonon scattering. The drain current reduction due to scattering is plotted on the right y-axis. It is defined as in Fig. 6.

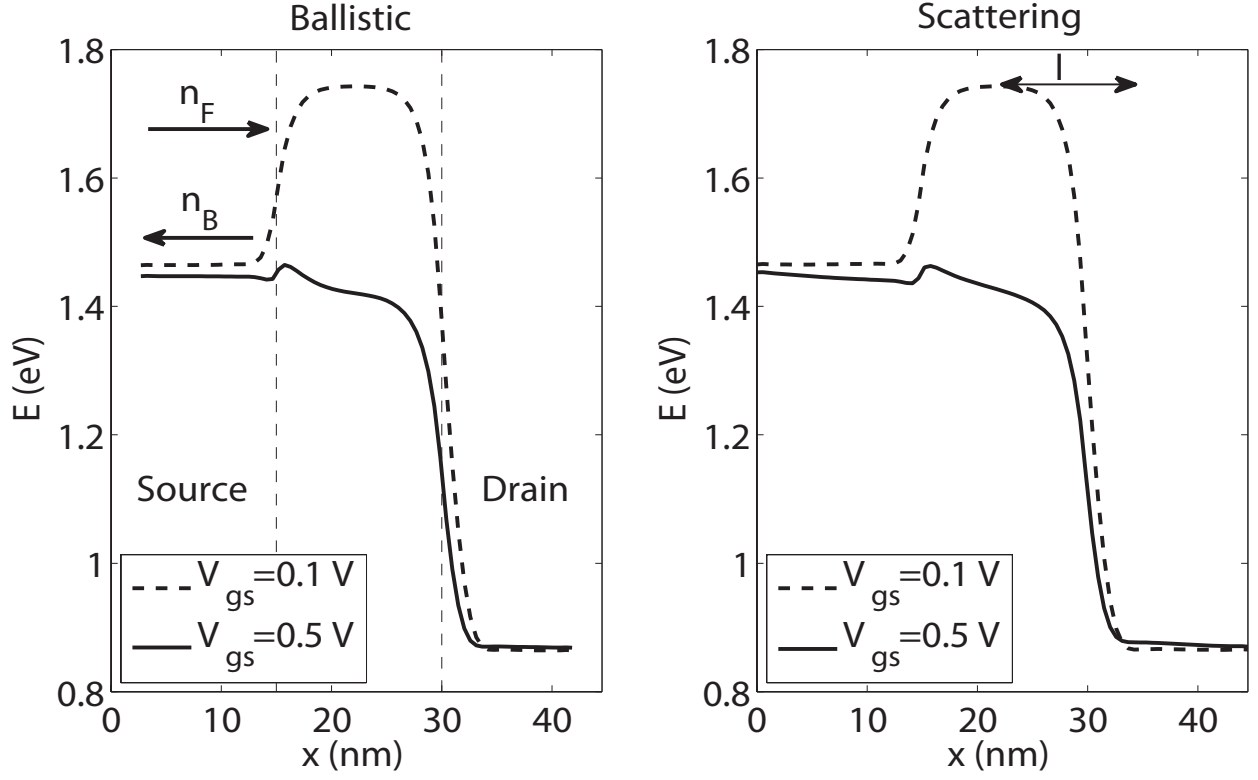


FIG. 8: Conduction band edges at  $V_{ds}=0.6$  V,  $V_{gs}=0.1$  V (dashed lines) and  $V_{gs}=0.5$  V (solid lines) in the nanowire with  $d=2.5$  nm. The band edges in case of ballistic transport are shown in the left subplot, those with electron-phonon scattering in the right subplot. The variable  $n_F$  ( $n_B$ ) describes the electrons moving forwards (backwards) to (from) the gate,  $l$  is the critical length for backscattering<sup>65</sup>.

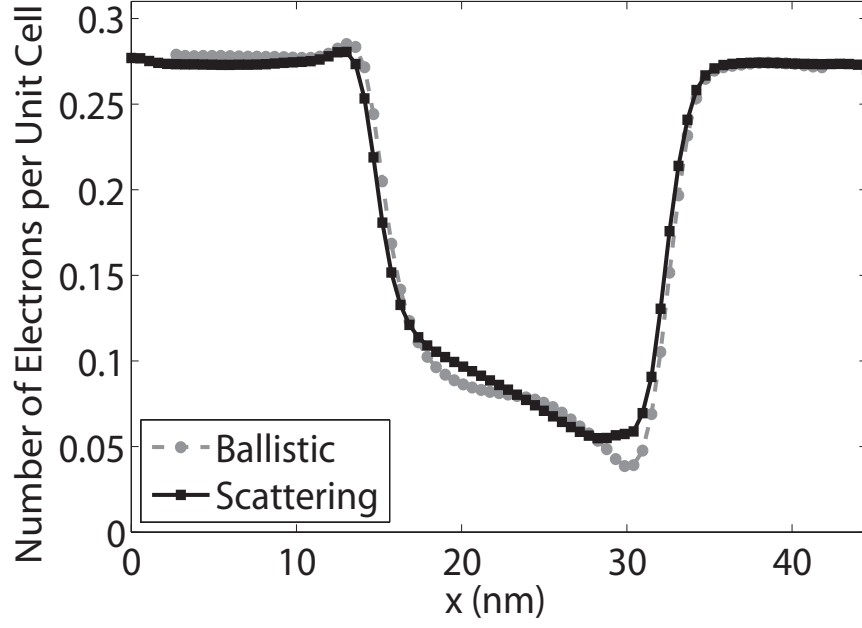


FIG. 9: Number of electrons per unit cell (ensemble of 4 atomic layers in the transport direction  $x$ ) for the Si GAA NW FET with a diameter  $d=2.5$  nm at  $V_{ds}=0.6$  V and  $V_{gs}=0.5$  V. The gray line with circles depicts the ballistic electron density, the black line with squares the carrier density in presence of electron-phonon scattering. The number of doping atoms per unit cell in the source and drain contacts is 0.274.

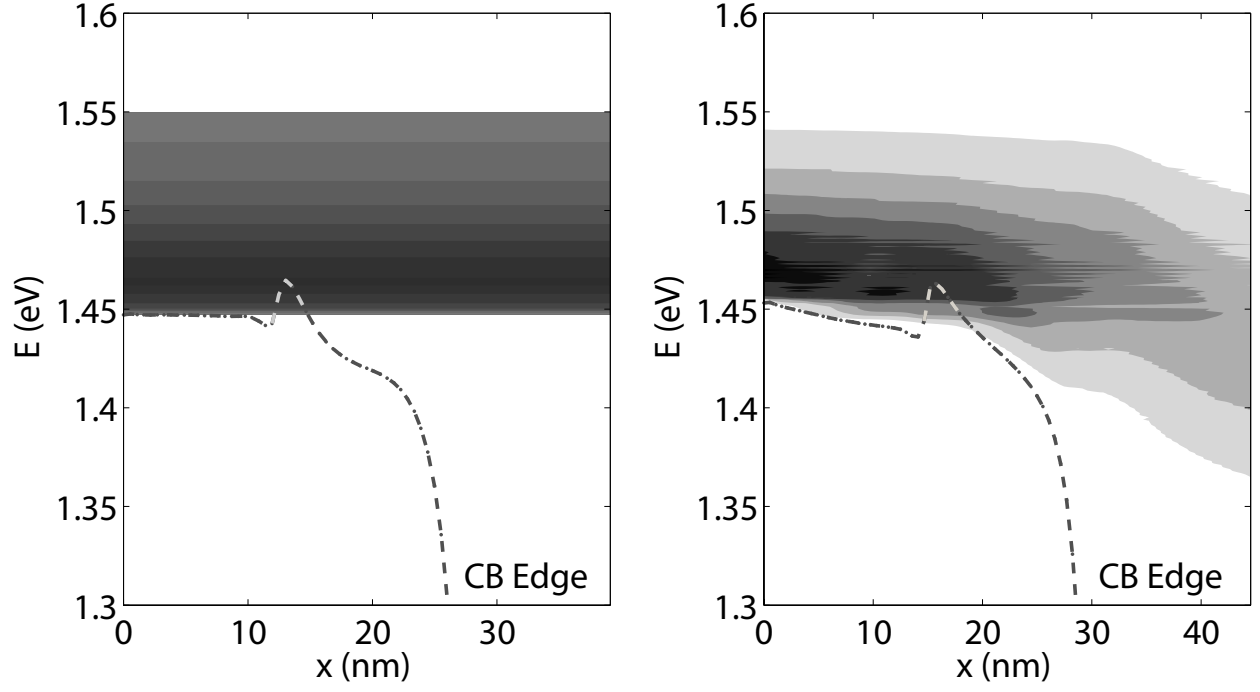


FIG. 10: Spectral current of the Si GAA NW FET with a diameter  $d=2.5$  nm from Fig. 4 at  $V_{gs}=0.5$  V and  $V_{ds}=0.6$  V. The left subplot represents the ballistic current (homogeneous), the right subplot the current with electron-phonon scattering. The dashed lines indicate the position of the conduction band (CB) edge.



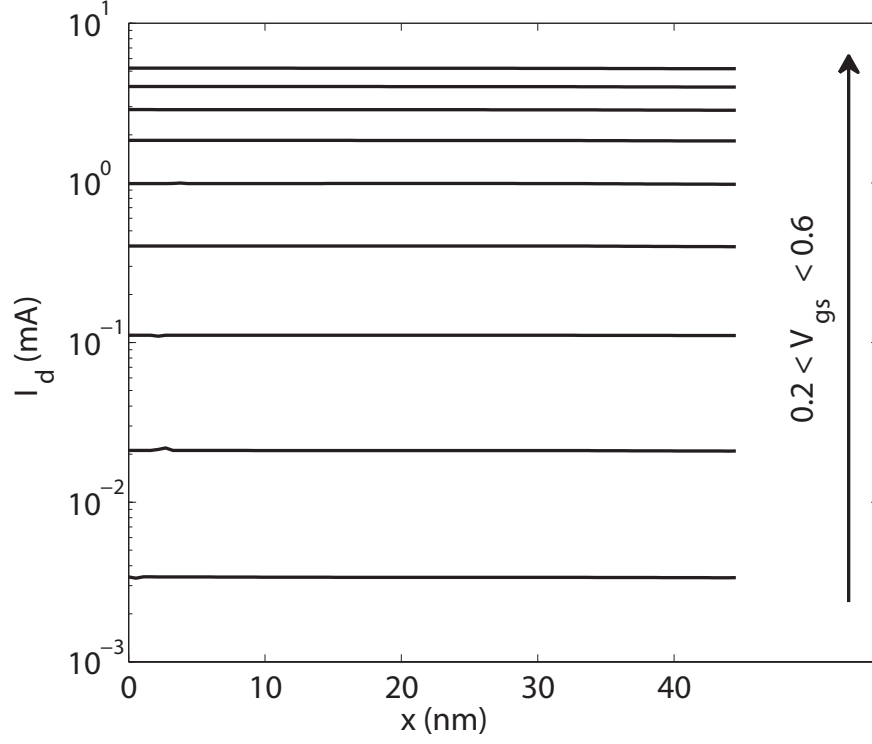


FIG. 11: Spatial current along the transport direction  $x$  of the Si GAA NW FET with a diameter  $d=2.5$  nm and in the presence of electron-phonon scattering. The currents are calculated at  $V_{ds}=0.6$  V and  $0.2 \leq V_{gs} \leq 0.6$  V.

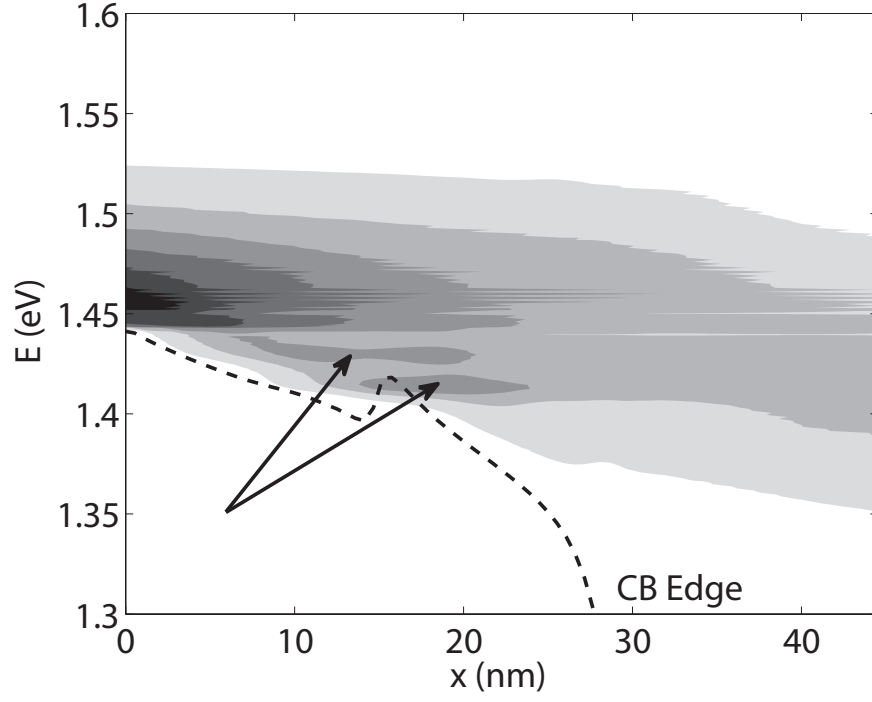


FIG. 12: Spectral current of the Si GAA NW FET with a diameter  $d=2.5$  and electron-phonon scattering at  $V_{gs}=V_{ds}=0.6$  V. The arrows indicate two regions with high current densities, separated by an energy difference of 15-16 meV.

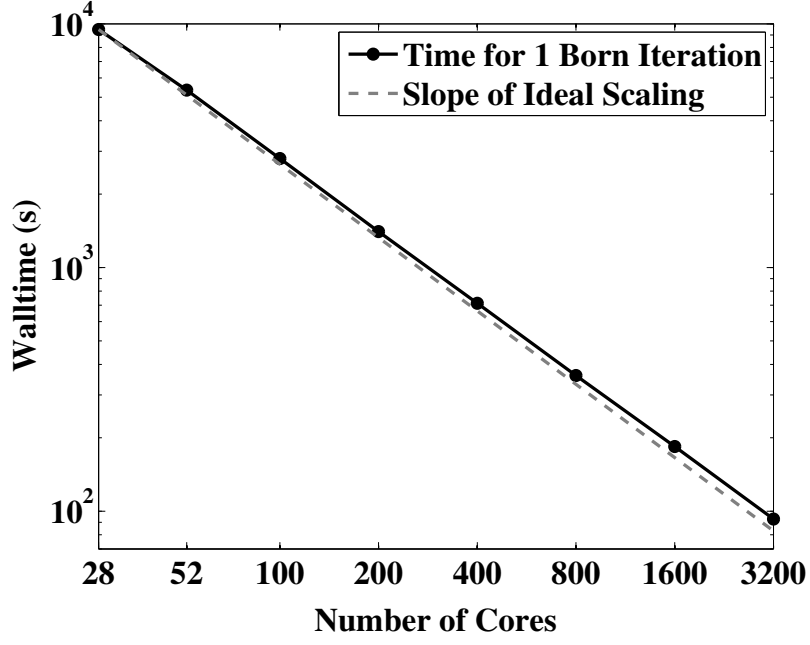


FIG. 13: Parallel execution time on a CRAY XT4 for the calculation of one Born iteration, i. e. for the solution of Eq. 1 to 4 and Eq. 14 for all the energies  $E$  on 28 to 3,200 cores. The test structure is a nanowire with  $n=2$  nm and  $N_E=1,571$  energy points. Each energy point is treated by four CPUs. Typically, 20 to 50 Born iterations are required to obtain the device current.